# FAIRCHILD

SEMICONDUCTOR®

# FDD6776A / FDU6776A\_F071 N-Channel PowerTrench<sup>®</sup> MOSFET 25 V, 7.5 m $\Omega$

# Features

- Max  $r_{DS(on)}$  = 7.5 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 17.7 A
- Max  $r_{DS(on)}$  = 17.0m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 13.2 A
- 100% UIL test
- RoHS Compliant

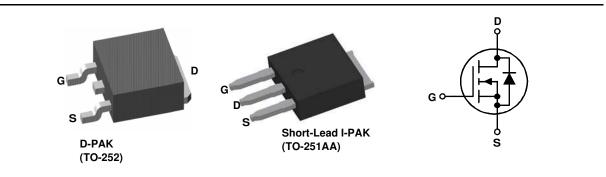


# **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(\text{on})}$  and fast switching speed.

# Applications

- Vcore DC-DC for Desktop Computers and Servers
- VRM for Intermediate Bus Architecture



## MOSFET Maximum Ratings T<sub>C</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage			25	V
V <sub>GS</sub>	Gate to Source Voltage			±20	V
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		30	
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		54	A
D	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	17.7	A
	-Pulsed			100	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	32	mJ
<b>D</b>	Power Dissipation	T <sub>C</sub> = 25 °C		39	
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	3.7	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature R	ange		-55 to +175	°C

### **Thermal Characteristics**

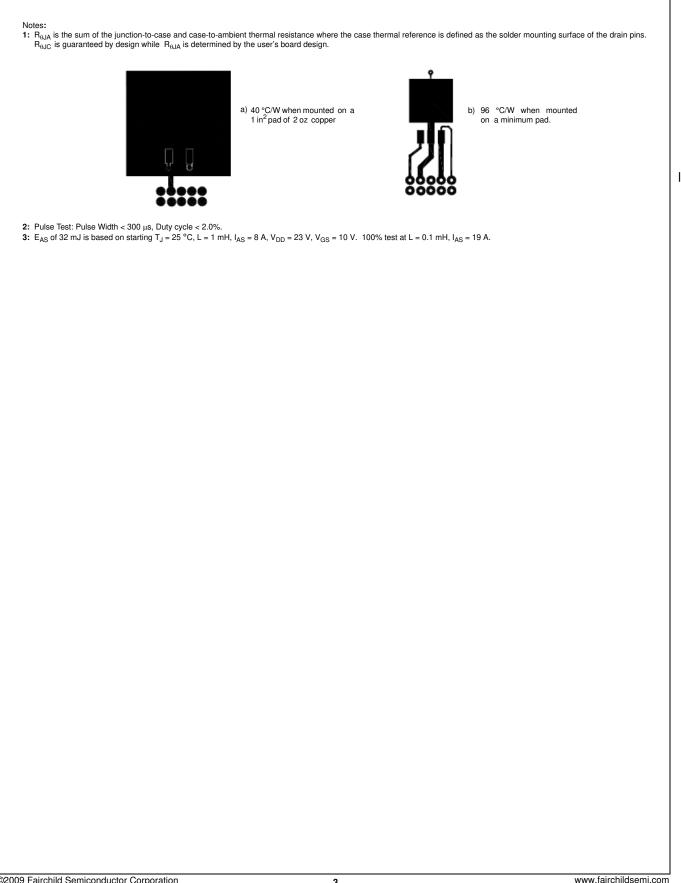
$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.8	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	40	C/VV

### Package Marking and Ordering Information

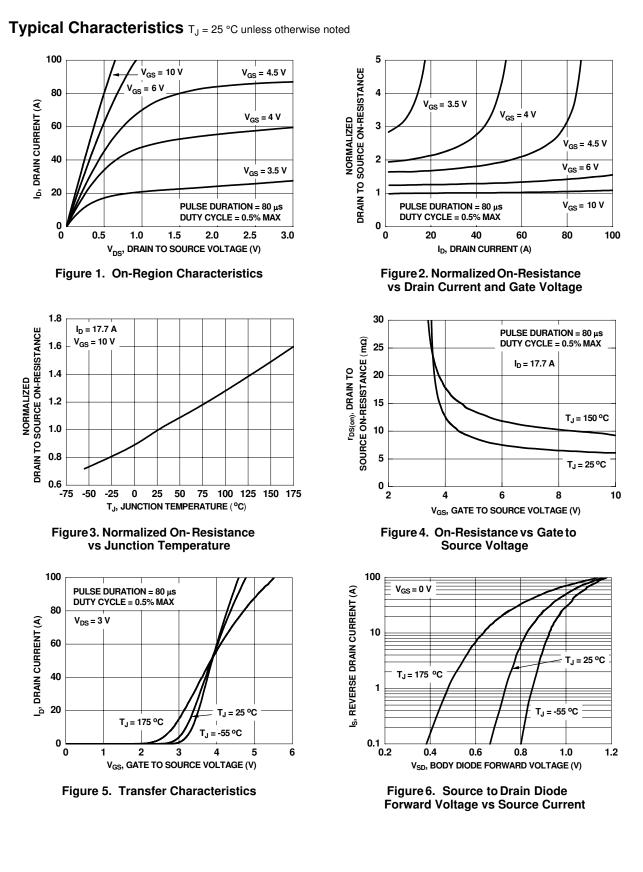
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD6776A	FDD6776A	D-PAK (TO-252)	13 "	12 mm	2500 units
FDU6776A	FDU6776A_F071	TO-251AA	N/A(Tube)	N/A	75 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	25			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		16		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 20 V, V_{GS} = 0 V$			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	1.0	1.9	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C
-		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 17.7 A		5.8	7.5	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 17.7 A Short-Lead I-PAK version		6.0	7.7	mΩ
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 13.2 \text{ A}$		12.6	17.0	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 13.2 A Short-Lead I-PAK version		12.8	17.2	
		$V_{GS}$ = 10 V, I <sub>D</sub> = 17.7 A, T <sub>J</sub> = 150 °C		8.8	11.4	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 17.7 A		84		S
	Characteristics					
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 13 V, V <sub>GS</sub> = 0 V,		1120	1490	pF
C <sub>oss</sub>	Output Capacitance	-f = 1 MHz		238	320	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			221	335	pF
R <sub>g</sub>	Gate Resistance			0.9		Ω
Switchin	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			8	16	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 13 V, I <sub>D</sub> = 17.7 A,		5	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		18	33	ns
t <sub>f</sub>	Fall Time	7		3	10	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		20	29	nC
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 13 V,$		12	17	nC
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 17.7 A		3.5		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			4.9		nC
Drain-So	urce Diode Characteristics					
V	Source to Drein Diade, Ferward Valtage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 3.1 A (Note 2)		0.8	1.2	V
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 17.7 A$ (Note 2)		0.9	1.3	V
t <sub>rr</sub>	Reverse Recovery Time			17	31	ns
	Reverse Recovery Charge	– I <sub>F</sub> = 17.7 A, di/dt = 100 A/μs		5	10	nC

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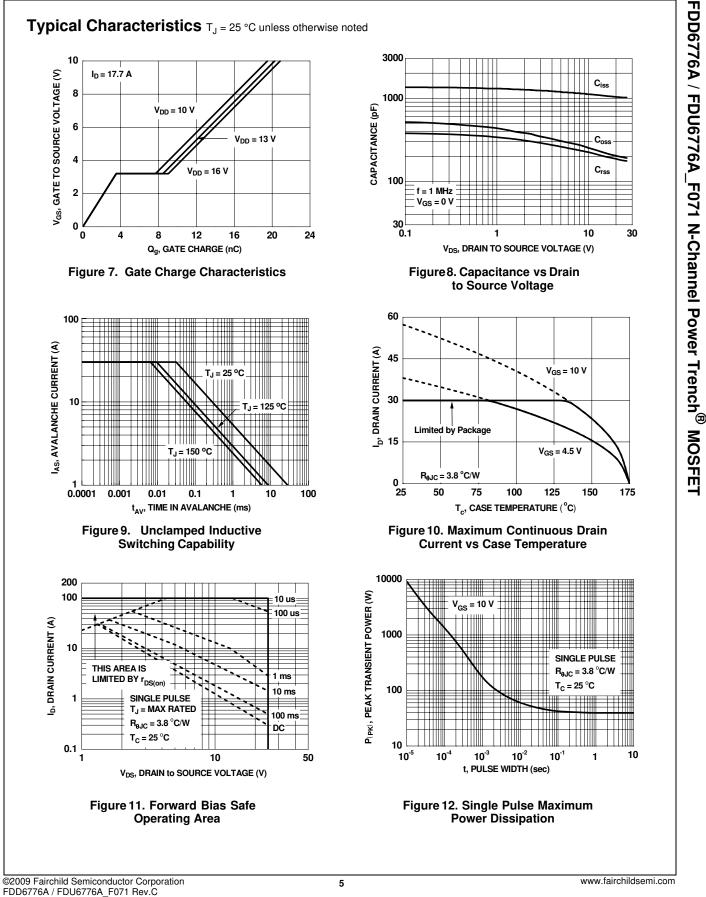


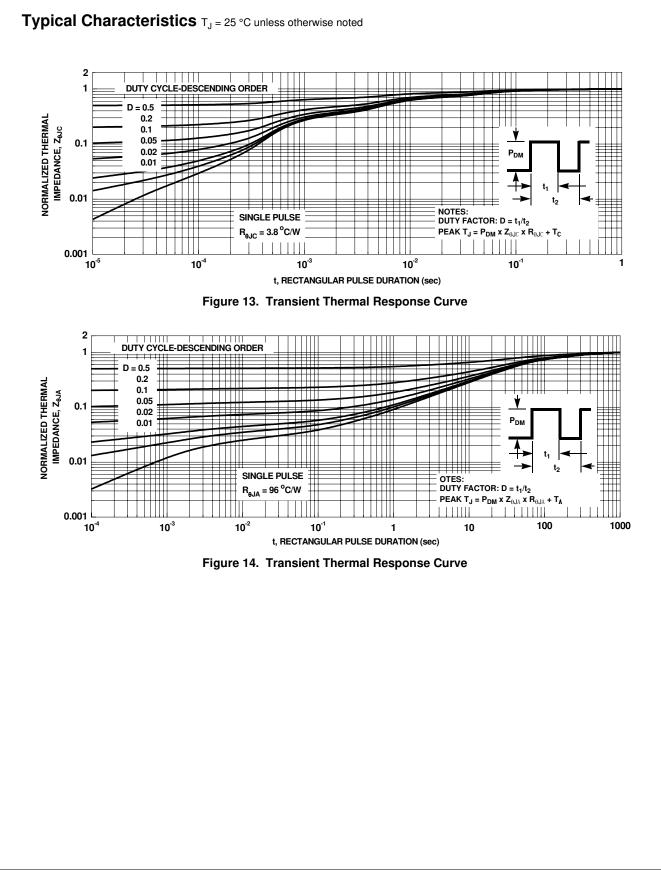
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FDD6776A / FDU6776A\_F071 N-Channel Power Trench<sup>®</sup> MOSFET

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